F R E E D 0 MUNIQUE AND INNOVATIVEPHOTONICSPHOTONIC SOLUTIONS

FREEDOM PHOTONICS is a manufacturer of unique and innovative photonic components, modules and subsystems. Our advanced semiconductor and dielectric photonic integration technology platforms are enabling new, high-performance fiber and free-space optical communication and sensing systems aimed at applications in diverse markets. If one of our standard products do not work for you, and you have a need that can be met through customizing our core photonic technology in Indium Phosphide, Gallium Arsenide or Silicon, we will be happy to provide a private label solution to support your needs.

Product Families

- Fast tunable lasers from 1250nm to 1750nm
- Swept tunable laser sources
- High power lasers: single and multi-mode, tunable 780nm to 1700nm
- Optical transmitters (fiber and free-space)
- High power photodetectors for RF photonics

Private Label Photonic Integrated Circuits (InP, GaAs, Silicon, Dielectric)

- Private label product building blocks (InP, GaAs, Si)
 - Active and passive waveguide components
 - Widely tunable lasers and high-power single mode lasers
 - High-speed modulators
 - High-power and speed photodetectors
 - Micro-optic assemblies
 - Hermetic optical modules
 - Controllers and fully integrated systems



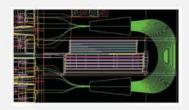
41 Aero Camino, Santa Barbara, CA 93117, 805-967-4900, freedomphotonics.com



UNIQUE AND INNOVATIVE PHOTONIC SOLUTIONS

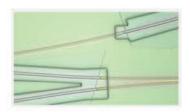
PRIVATE LABEL PRODUCTS

Our team's world class expertise in vertically integrated photonic product design (device-module-system) and production has helped many customers prove feasibility, develop, and deploy new products for a variety of applications. Let us help you be successful by providing a complete design to manufacturing solution for your market needs. Focus on what you know best and leave the photonics piece to us.



Photonic Device Design

Epitaxial structure design Passive component design Active component design Custom semiconductor laser design



Photonic Chip Fabrication

Epitaxial structure specification and procurement Fabrication process design and development Fast turn-around low-volume fabrication Implementation and management of volume production fabrication



Module Design and Photonic Packaging

Mechanical, electrical and optical design Packaging process development In-house packaging using laser welding and/or UV curing Implementation and management of volume production



Subsystem Design

Mixed signal control circuit design Multilayer mixed signal printed circuit board layout PCB fabrication, assembly, test and integration Implementation and management of volume production



Testing

Optical performance testing Electrical performance testing Burn-in and environmental testing Qualification testing



Manufacturing

Complete photonic chip design and fabrication Chip-on-submount assembly Photonic module assembly Implementation and management of low to high volume production